



# Anthem Lead Tinning System

The Anthem Lead Tinning System is a production volume lead tinning system for electronic component tinning and re-tinning applications. The Anthem can be configured with 4 stations, including a 35-lb solder pot for scavenge, a flux station, a preheat station, and a dynamic solder pot for high precision tinning application, direct drive ball screw motion, and an automatic solder pot dross wiper. Optional rotation is available to handle QFPs and other multi-sided components.

### **Anthem**

## operations Lead Tinning System

Computer Standard

Station Configurability Standard; static solder, dynamic solder, flux

Accuracy  $X \mid Z Axes \pm .002" \mid 0.025mm$ 

Programmability Unlimited program storage capacity Immersion Depth Programmable ± .002" | 0.0125mm

Speed in/out Programmable 0-3"/second Immersion Time Programmable in milliseconds Interpolated Motion 4 Axis Simultaneous Motion

#### Solder Management

Temp Control PID proportioning (0-400°C) ± 2°C

Solder Pot Electro Polished Stainless Steel

Solder Range Dynamic (WxLxD) 2.5 x 4.5 x 4" | mm

Solder Range Static (WxLxD) 8.5 x 5.5 x 2.75" | mm

Static Dross Wiper Standard Lead Free Ready Standard

Flux Station Range 5 x 8 x 4" | 125 x 200 x 100 mm

Dynamic Flux Option Recirculating

#### Additional Stations

Capacity Up to 4 Stations

Rinse Station Option

2nd Flux Statio Option

Dry Station Option

PreHeat Station Option

#### Physical

Electrical IR 0 - 500 C (± 2 C) 220VAC | 1Ø 3 Wire | 50-60hz | 30amp

Certification UL and CE Labeled

Air 80 PSI

Exhaust 20 SCFH (ft3) | 0.56 CMH (m3) Nitrogen <100 PPM @ 100 CFH (option)











